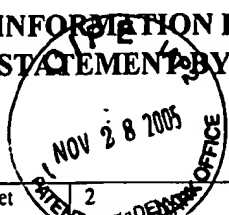


FORM PTO-1449/A and B (Modified)		APPLICATION NO.: 09/352,494	ATTY. DOCKET NO.: Z2002-700110 (Prior Docket No. 03588.P002)
<b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b>		FILING DATE: July 13, 1999	CONFIRMATION NO.: 2351
		APPLICANT: Kevin Brehmer et al.	
		GROUP ART UNIT: 2612	EXAMINER: Tuan V. Ho
Sheet	2		

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		APPLICANT: Kevin Brehmer et al.	
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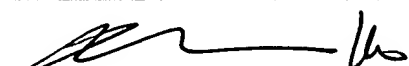
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#EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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